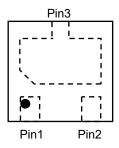


Transient Voltage Suppressor

Description

The PTVSHC3N24VUP Transient Voltage Suppressor is designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and PDA's. They feature large cross-sectional area junctions for conducting high transient currents, offer desirable electrical characteristics for board level protection, such as fast response time, lower operating voltage, lower clamping voltage and no device degradation when compared to MLVs.

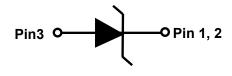
The PTVSHC3N24VUP protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. The PTVSHC3N24VUP is available in a DFN2 \times 2-3L package with working voltages of 24 volt. It is used to meet the ESD immunity requirements of IEC 61000-4-2.



Pin configuration

Feature

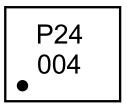
- > 6600W Peak pulse power per line (t_P = 8/20µs)
- DFN2×2-3L package
- Response time is typically < 1 ns</p>
- Protect one I/O or power line
- > RoHS compliant
- Transient protection for data lines to IEC61000-4-2(ESD) ±30KV(air), ±30KV(contact); IEC 61000-4-4 (EFT) 80A (5/50ns), IEC 61000-4-5 (Lightning) 180A (8/20us)



Circuit Diagram

Applications

- Cell phone handsets and accessories
- Personal digital assistants (PDA's)
- Notebooks, desktops, and servers
- Portable instrumentation
- Cordless phones
- Digital cameras
- Peripherals
- MP3 players



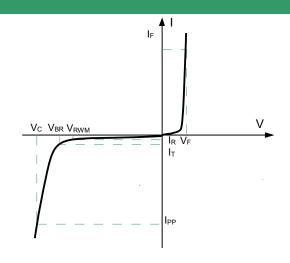
Marking (Top View)

Mechanical Characteristics

- Lead finish:100% matte Sn(Tin)
- Mounting position: Any
- Qualified max reflow temperature:260°C
- Pure tin plating: 7 ~ 17 um

Electronics Parameter

Symbol	Parameter		
V _{RWM}	Peak Reverse Working Voltage		
I _R	Reverse Leakage Current @ V _{RWM}		
V_{BR}	Breakdown Voltage @ I⊤		
lτ	Test Current		
I _{PP}	Maximum Reverse Peak Pulse Current		
Vc	Clamping Voltage @ IPP		
P _{PP}	Peak Pulse Power		
CJ	Junction Capacitance		
lF	Forward Current		
V _F	Forward Voltage @ I _F		



Electrical characteristics per line@25℃(unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Peak Reverse Working Voltage	V _{RWM}				24	V
Forward Voltage	VF	I _F =10mA		0.75		V
Breakdown Voltage	V _{BR}	I _t =1mA	25	27	29	V
Reverse Leakage Current	I _R	V _{RWM} =24V			1	μA
Maximum Reverse Peak Pulse Current	I _{PP}			180		Α
Clamping Voltage	Vc	I _{PP} =100A t _P = 8/20μs		30	32	V
Clamping Voltage	Vc	I _{PP} =180A t _P = 8/20μs		34	36	V
Junction Capacitance	Cj	V _R =0V f = 1MHz		670	850	pF

Notes: Measured from pin 1 & pin 2 to pin 3

Absolute maximum rating@25℃

Rating	Symbol	Value	Units
Peak Pulse Power (t _P = 8/20μS)	P _{pp}	6600	W
Lead Soldering Temperature	T∟	260 (10 sec)	°C
Operating Temperature	TJ	-55 to +150	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Typical Characteristics

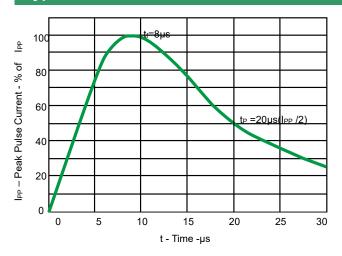


Fig 1.Pulse Waveform

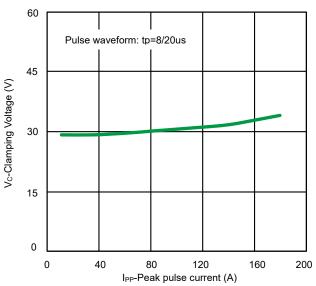


Fig 3. Clamping voltage vs. Peak pulse current

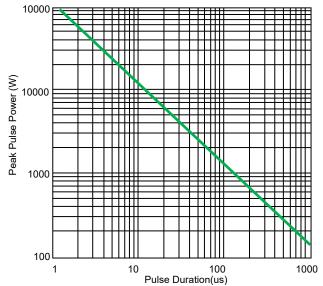


Fig 5. Non Repetitive Peak Pulse Power vs. Pulse time

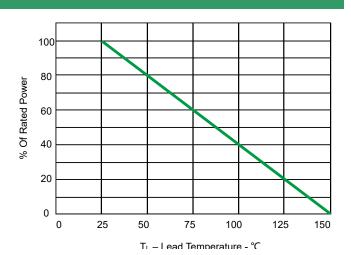


Fig 2.Power Derating Curve

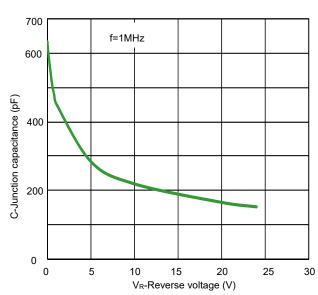
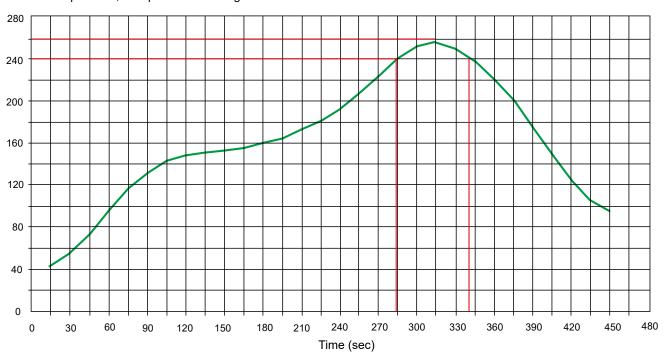


Fig 4. Capacitance vs. Reveres voltage

Solder Reflow Recommendation

Peak Temp=257°C, Ramp Rate=0.802deg. °C/sec

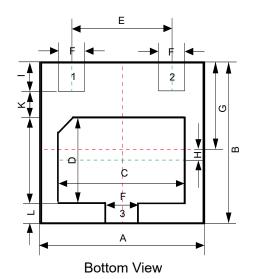


PCB Design

For TVS diodes a low-ohmic and low-inductive path to chassis earth is absolutely mandatory in order to achieve good ESD protection. Novices in the area of ESD protection should take following suggestions to heart:

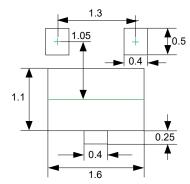
- > Do not use stubs, but place the cathode of the TVS diode directly on the signal trace.
- Do not make false economies and save copper for the ground connection.
- Place via holes to ground as close as possible to the anode of the TVS diode.
- > Use as many via holes as possible for the ground connection.
- > Keep the length of via holes in mind! The longer the more inductance they will have.

Product dimension (DFN2×2-3L)





Dim	Millimeters		
Dilli	MIN	MAX	
Α	1.90	2.10	
В	1.90	2.10	
С	1.40	1.60	
D	0.90	1.15	
E	1.30BSC		
F	0.25	0.40	
G	0.90	1.10	
Н	0.20	0.30	
I	0.32 0.48		
J	0.50 0.65		
К	0.20 0.45		
L	0.15 0.30		



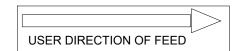
Recommended Soldering Pad

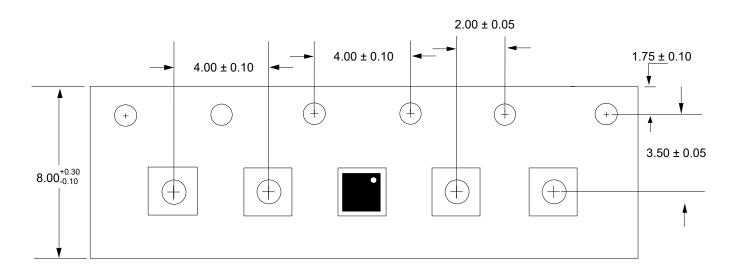
Unit:mm

Ordering information

Device	Package	Reel	Shipping
PTVSHC3N24VUP	DFN2×2-3L (Pb-Free)	7"	3000 / Tape & Reel

Load with information





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